

## N-channel 650 V, 0.48 Ω typ., 8 A MDmesh<sup>™</sup> M2 Power MOSFET in a PowerFLAT 5x6 HV package

Datasheet - production data

### Features

Order code	er code V <sub>DS</sub> R <sub>DS(on)</sub> max.		Iр
STL12HN65M2	650 V	0.55 Ω	6 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### Description

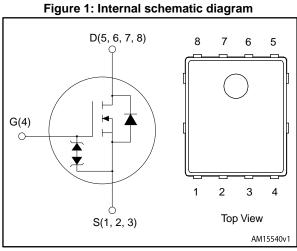
This device is an N-channel Power MOSFET developed using MDmesh<sup>™</sup> M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

## Table 1: Device summarv

Order code		Marking	Package	Packing		
	STL12HN65M2	12N65M2	PowerFLAT 5x6 HV	Tape and reel		

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This is information on a product in full production.



PowerFLAT<sup>™</sup> 5x6 HV

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## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	±25	V
lp <sup>(1)</sup>	Drain current (continuous) at T <sub>case</sub> = 25 °C	6	А
ID."	Drain current (continuous) at T <sub>case</sub> = 100 °C	4	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	24	А
Ртот	Total dissipation at T <sub>case</sub> = 25 °C	52	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50 V/ns	
T <sub>stg</sub>	Storage temperature range	55 to 150 °C	
Tj	Operating junction temperature range	-55 to 150 °C	

#### Notes:

<sup>(1)</sup> Limited by package.

 $^{\left( 2\right) }$  Pulse width is limited by safe operating area.

 $^{(3)}$  Isp  $\leq 6$  A, di/dt = 400 A/µs, V\_DS(peak) < V(BR)DSS, V\_DD = 400 V

 $^{(4)}$  V<sub>DS</sub>  $\leq$  520 V

#### Table 3: Thermal data

Symbol	ol Parameter		Unit
R <sub>thj-case</sub>	Thermal resistance junction-case		°C/W
Rthj-pcb <sup>(1)</sup>	R <sub>thj-pcb</sub> <sup>(1)</sup> Thermal resistance junction-pcb		C/vv

#### Notes:

 $^{(1)}$ When mounted on an 1 inch<sup>2</sup> FR-4 board, 2 oz Cu.

#### Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lar	Avalanche current, repetitive or non-repetitive (pulse width limited by $T_{jmax.}$ )	1.6	А
Eas	Single pulse avalanche energy (starting $T_j = 25 \text{ °C}$ , $I_D = I_{AR}$ , $V_{DD} = 50 \text{ V}$ )	250	mJ



## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 V$ , $I_D = 1 mA$	650			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 650 V$			1	
IDSS	Zero-gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 650 V,$ $T_{case} = 125 \ ^{\circ}C^{(1)}$			100	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS}$ = 0 V, $V_{GS}$ = ±25 V			±10	μA
VGS(th)	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.48	0.55	Ω

#### Notes:

<sup>(1)</sup>Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	535	-	
Coss	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	25	-	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	1.1	-	P
Coss eq. <sup>(1)</sup>	Equivalent output capacitance	$V_{DS} = 0$ to 520 V, $V_{GS} = 0$ V	-	144	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	7	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 8 A,	-	16.7	-	
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 10 V (see Figure 15: "Test circuit	-	2.6	-	nC
Q <sub>gd</sub>	Gate-drain charge	for gate charge behavior")	-	8.6	-	

#### Table 6: Dynamic

#### Notes:

 $^{(1)}$  Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDss.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 325 V, I <sub>D</sub> = 4 A	-	9	-	
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 14: "Test circuit	-	7	-	
t <sub>d(off)</sub>	Turn-off delay time	for resistive load switching	-	34	-	ns
tr	Fall time	times" and Figure 19: "Switching time waveform")	-	13.5	-	



#### Electrical characteristics

	Tal	ole 8: Source-drain diode				
Symbol	Symbol Parameter Test conditions				Max.	Unit
I <sub>SD</sub> <sup>(1)</sup>	Source-drain current		-		6	А
I <sub>SDM</sub> <sup>(2)</sup>	Source-drain current (pulsed)		-		24	А
Vsd <sup>(3)</sup>	Forward on voltage	$V_{GS} = 0 V$ , $I_{SD} = 6 A$	-		1.6	V
trr	Reverse recovery time	I <sub>SD</sub> = 8 A, di/dt = 100 A/µs,	-	313		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 60 V (see Figure 16: "Test circuit for	-	2.7		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	17		А
trr	Reverse recovery time	$I_{SD} = 8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	462		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 16: "Test circuit for	-	4.1		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	17.5		A

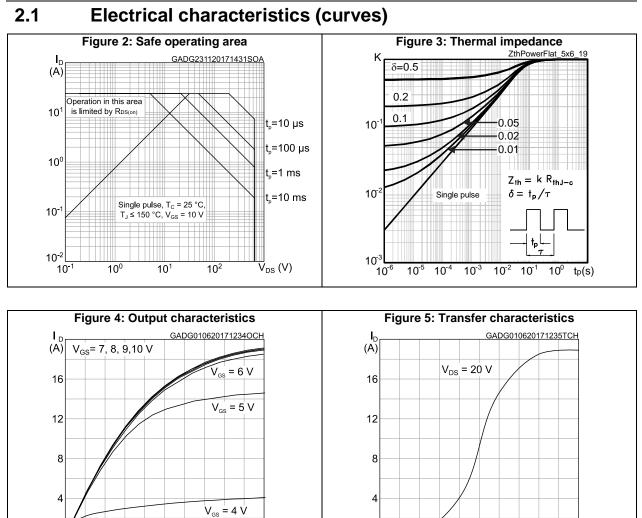
#### Notes:

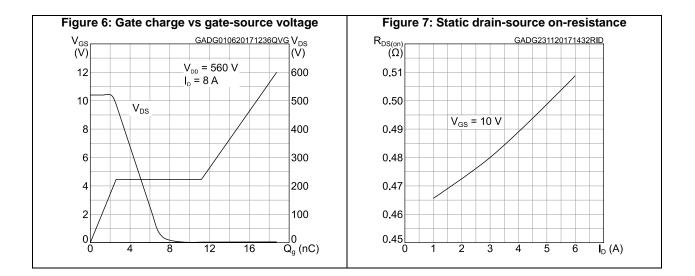
<sup>(1)</sup>Limited by package

 $^{\left( 2\right) }$  Pulse width is limited by safe operating area.

 $^{(3)}$  Pulse test: pulse duration = 300  $\mu s,$  duty cycle 1.5%







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 $\overline{V}_{GS}(V)$ 

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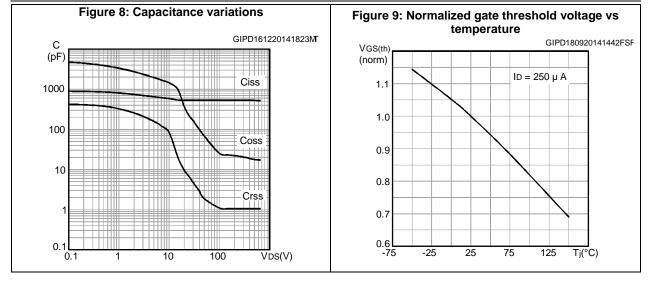
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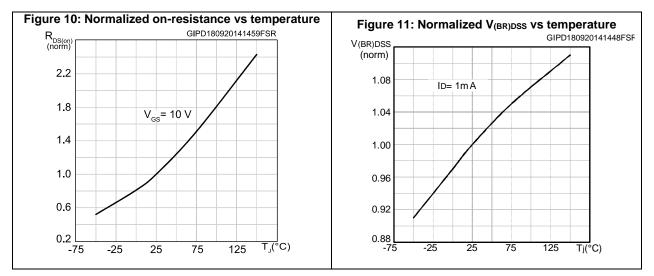
16

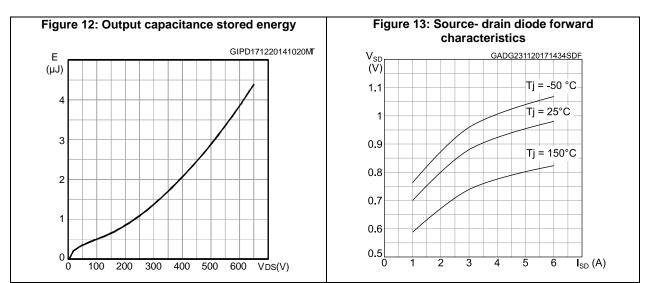
 $\overline{V}_{DS}(V)$ 

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#### **Electrical characteristics**

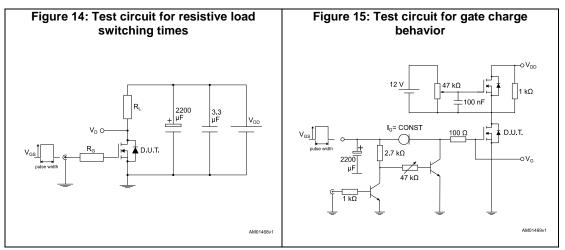


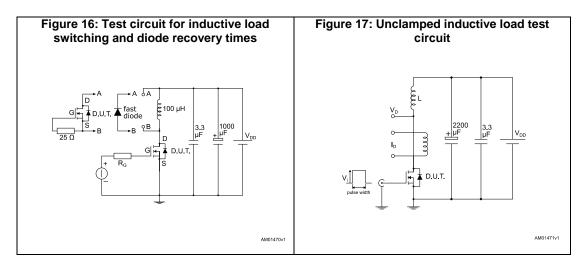


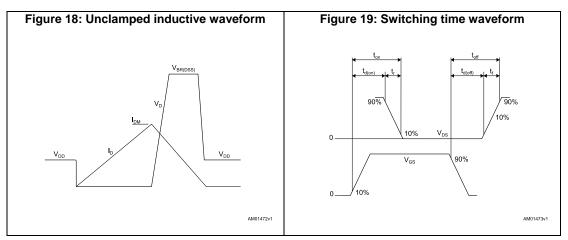


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### 3 Test circuits







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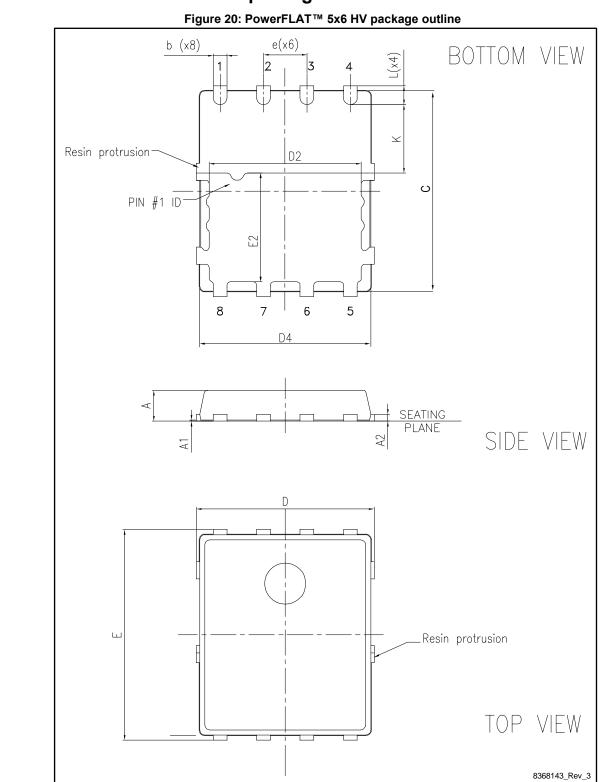


### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



Package information



### 4.1 PowerFLAT<sup>™</sup> 5x6 HV package information



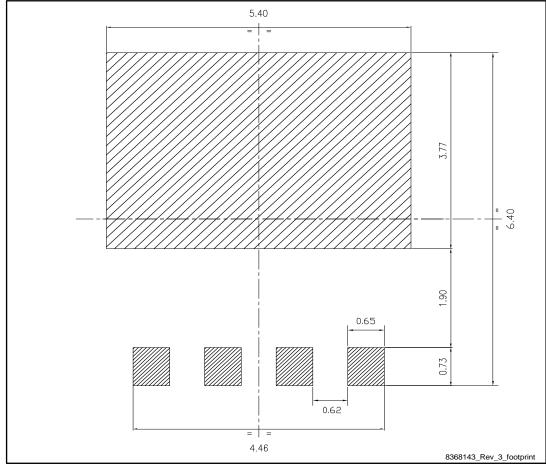


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#### Package information

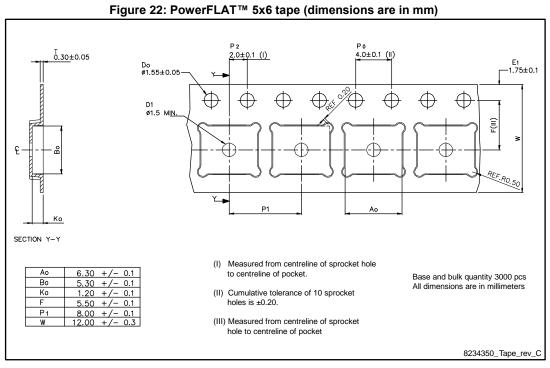
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	Table 9: PowerFLAT™	5x6 HV mechanical data	l			
Dim	mm					
Dim.	Min.	Тур.	Max.			
A	0.80		1.00			
A1	0.02		0.05			
A2		0.25				
b	0.30		0.50			
С	5.8	6	6.1			
D	5.10	5.20	5.30			
E	6.05	6.15	6.25			
E2	3.10	3.20	3.30			
D2	4.30	4.40	4.50			
D4	4.8	5	5.1			
е		1.27				
L	0.50	0.55	0.60			
К	1.90	2.00	2.10			



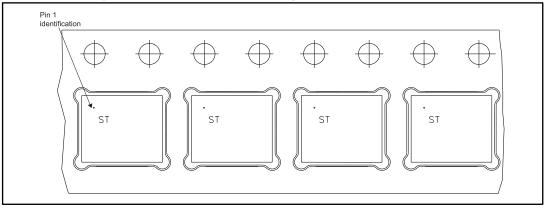


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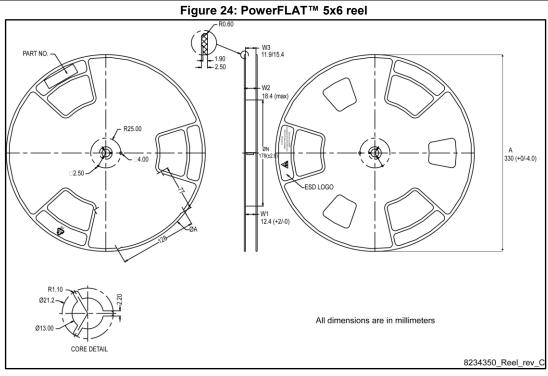
### 4.2 PowerFLAT<sup>™</sup> 5x6 packing information











#### **Revision history** 5

Date	Revision	Changes
29-Nov-2017	1	First release



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